

To our customers,

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## Old Company Name in Catalogs and Other Documents

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April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

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# MOS FIELD EFFECT TRANSISTOR

# μPA1919

## P-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

### DESCRIPTION

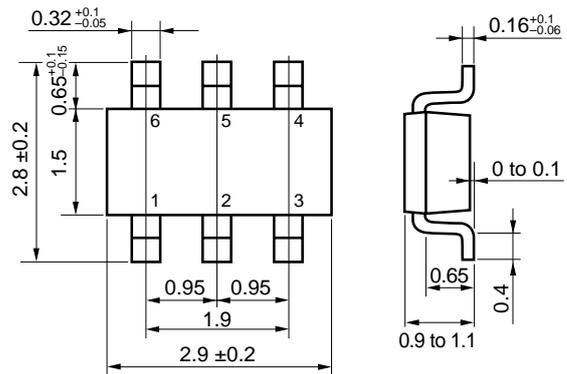
The μPA1919 is a switching device, which can be driven directly by a 2.5 V power source.

This device features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

### FEATURES

- 2.5 V drive available
  - Low on-state resistance
- $R_{DS(on)1} = 58 \text{ m}\Omega \text{ MAX. (} V_{GS} = -4.5 \text{ V, } I_D = -3.0 \text{ A)}$   
 $R_{DS(on)2} = 60 \text{ m}\Omega \text{ MAX. (} V_{GS} = -4.0 \text{ V, } I_D = -3.0 \text{ A)}$   
 $R_{DS(on)3} = 84 \text{ m}\Omega \text{ MAX. (} V_{GS} = -2.5 \text{ V, } I_D = -3.0 \text{ A)}$

### <R> PACKAGE DRAWING (Unit: mm)



1, 2, 5, 6 : Drain  
 3 : Gate  
 4 : Source

### ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA1919TE	SC-95 (Mini Mold Thin Type)

Marking: TX

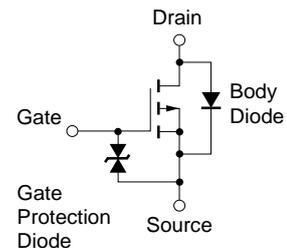
### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C)

Drain to Source Voltage (V <sub>GS</sub> = 0 V)	V <sub>DSS</sub>	-20	V
Gate to Source Voltage (V <sub>DS</sub> = 0 V)	V <sub>GSS</sub>	±12	V
Drain Current (DC) (T <sub>A</sub> = 25°C)	I <sub>D(DC)</sub>	±6.0	A
Drain Current (pulse) <sup>Note1</sup>	I <sub>D(pulse)</sub>	±24	A
Total Power Dissipation	P <sub>T1</sub>	0.2	W
Total Power Dissipation <sup>Note2</sup>	P <sub>T2</sub>	2.0	W
Channel Temperature	T <sub>ch</sub>	150	°C
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C

- Notes 1.** PW ≤ 10 μs, Duty Cycle ≤ 1%  
**2.** Mounted on FR-4 board of 2500 mm<sup>2</sup> x 1.6 mm, t ≤ 5 sec.

**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

### EQUIVALENT CIRCUIT

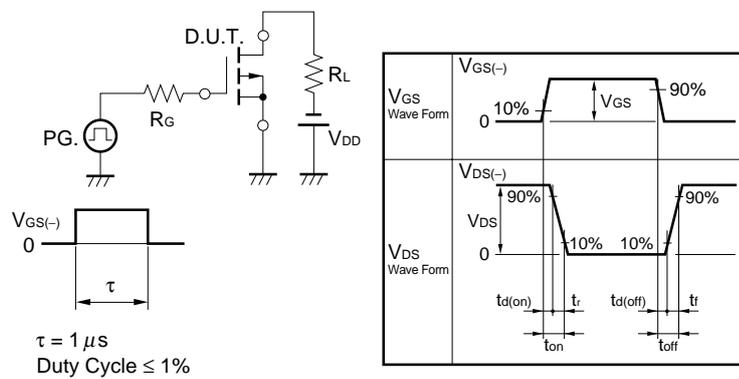


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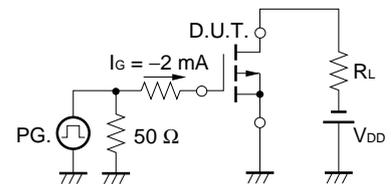
**ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)**

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	I <sub>bss</sub>	V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0 V			-1.0	μA
Gate Leakage Current	I <sub>gss</sub>	V <sub>GS</sub> = ±12 V, V <sub>DS</sub> = 0 V			±10	μA
Gate to Source Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -1.0 mA	-0.5	-1.0	-1.5	V
Forward Transfer Admittance	y <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -3.0 A	5.0	9.5		S
Drain to Source On-state Resistance	R <sub>DS(on)1</sub>	V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -3.0 A		46	58	mΩ
	R <sub>DS(on)2</sub>	V <sub>GS</sub> = -4.0 V, I <sub>D</sub> = -3.0 A		48	60	mΩ
	R <sub>DS(on)3</sub>	V <sub>GS</sub> = -2.5 V, I <sub>D</sub> = -3.0 A		63	84	mΩ
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -10 V		680		pF
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V		170		pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz		95		pF
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = -10 V, I <sub>D</sub> = -3.0 A		15		ns
Rise Time	t <sub>r</sub>	V <sub>GS</sub> = -4.0 V		19		ns
Turn-off Delay Time	t <sub>d(off)</sub>	R <sub>G</sub> = 10 Ω		47		ns
Fall Time	t <sub>f</sub>			65		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> = -16 V		6.0		nC
Gate to Source Charge	Q <sub>GS</sub>	V <sub>GS</sub> = -4.0 V		1.5		nC
Gate to Drain Charge	Q <sub>GD</sub>	I <sub>D</sub> = -6.0 A		2.4		nC
Diode Forward Voltage	V <sub>F(S-D)</sub>	I <sub>F</sub> = 6.0 A, V <sub>GS</sub> = 0 V		0.93		V

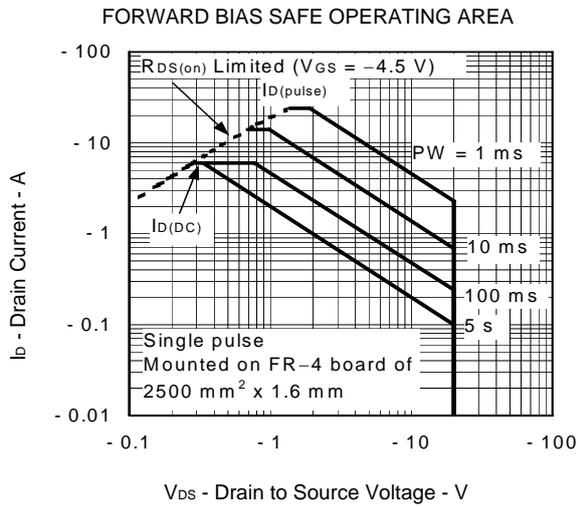
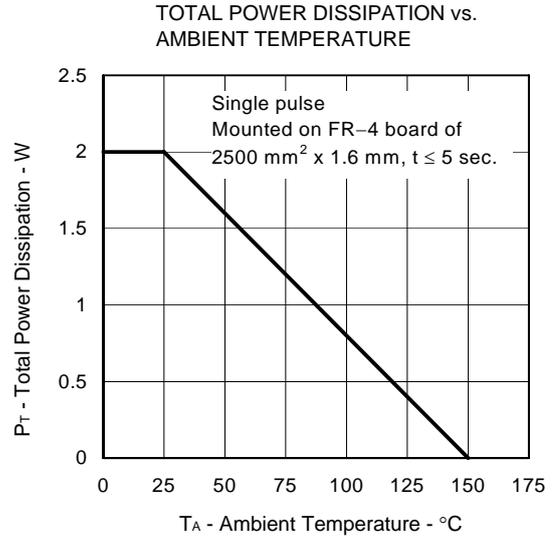
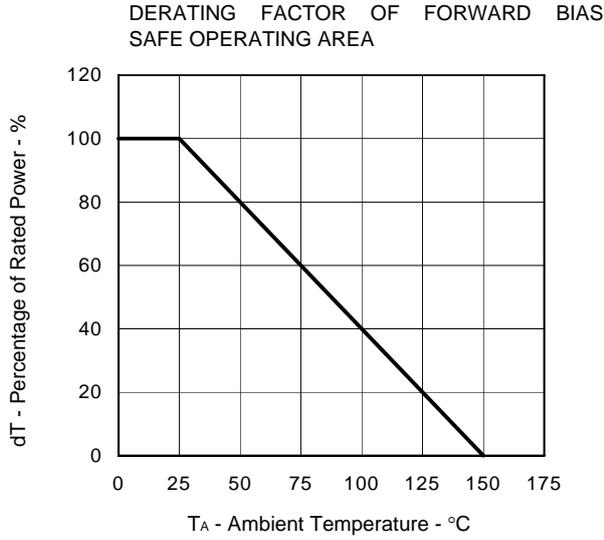
**TEST CIRCUIT 1 SWITCHING TIME**



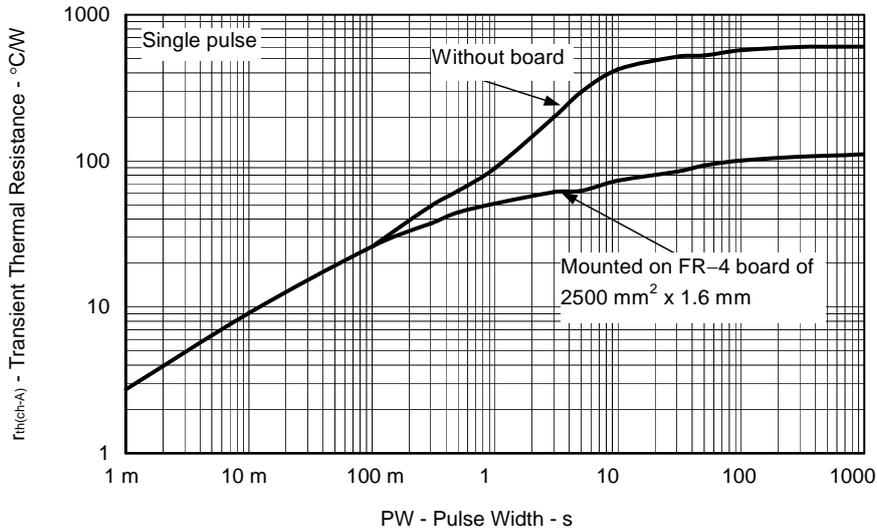
**TEST CIRCUIT 2 GATE CHARGE**



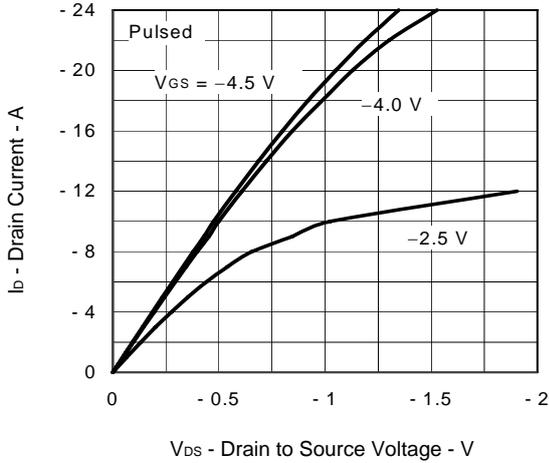
TYPICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ )



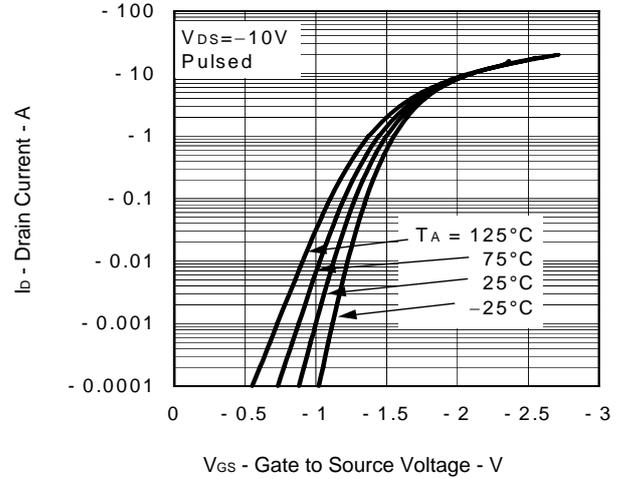
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



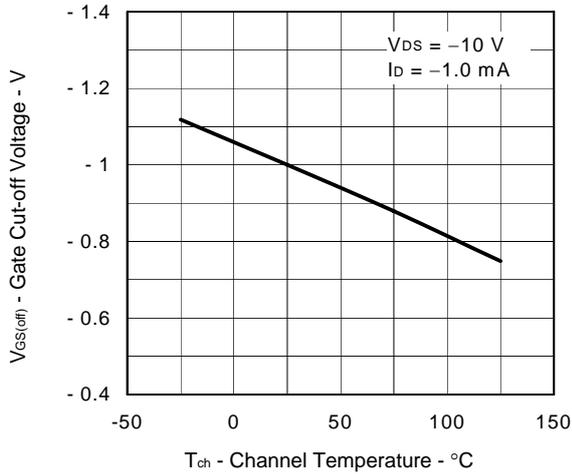
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



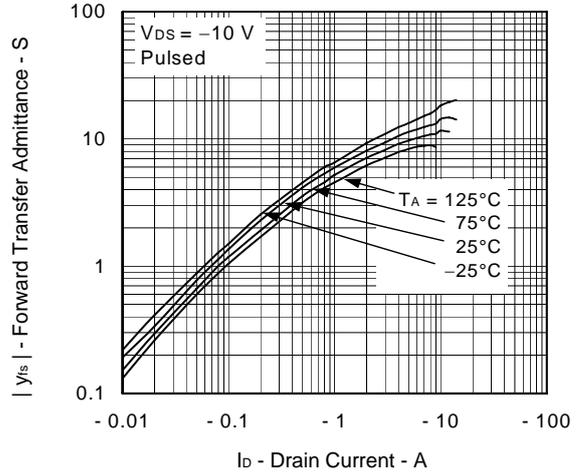
FORWARD TRANSFER CHARACTERISTICS



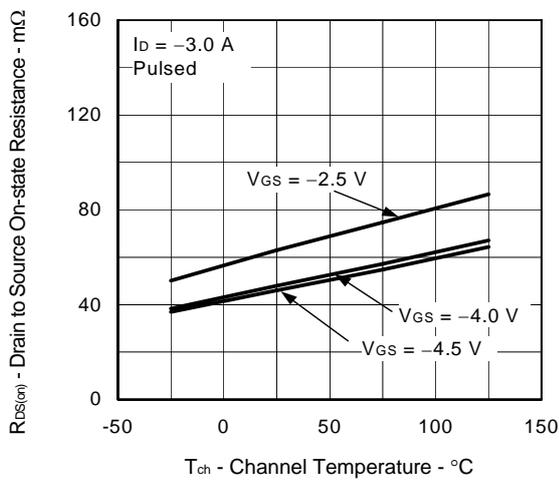
GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



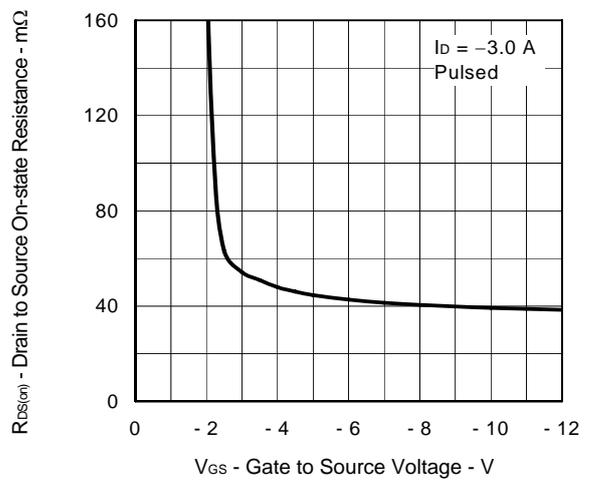
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



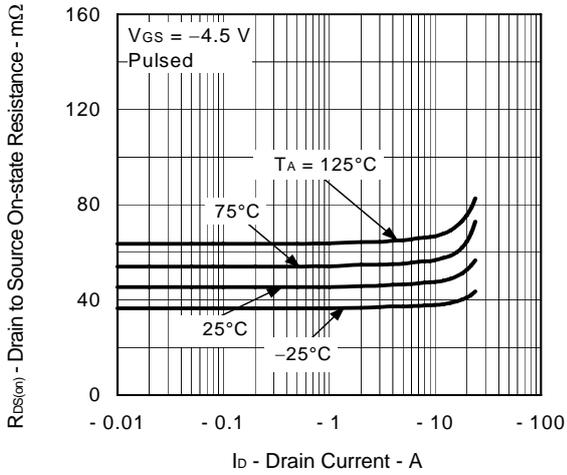
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



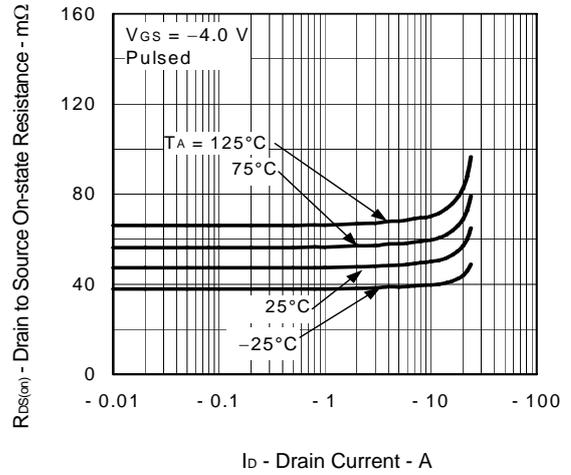
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



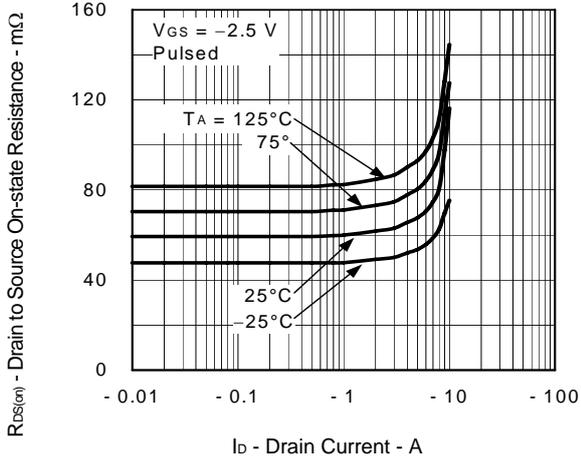
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



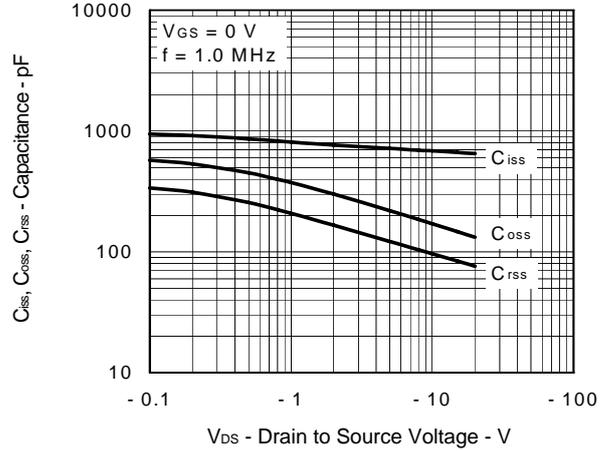
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



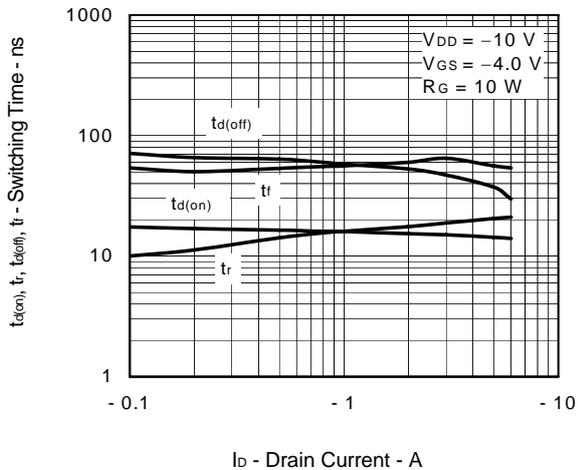
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



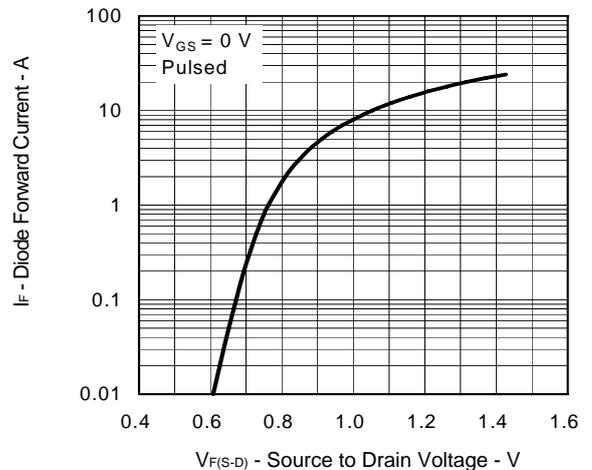
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

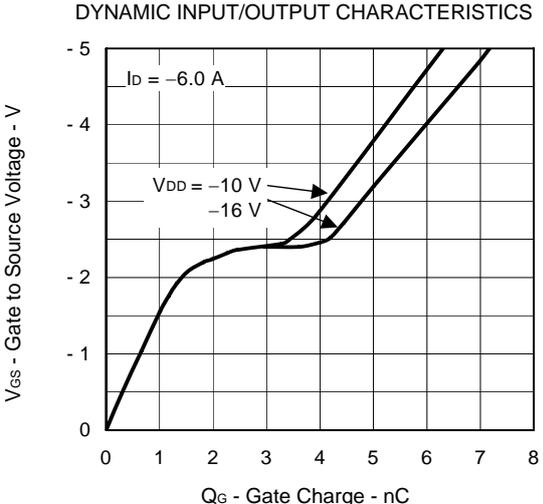


SWITCHING CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE





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